UNR8231/8231A (UN8231/8231A)

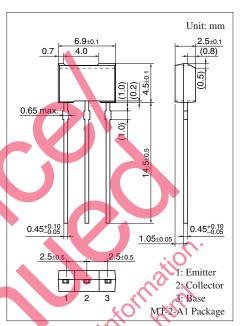
Silicon NPN epitaxial planar type

For switching

- Features
- \bullet High forward current transfer ratio h_{FE}
- Resistor built-in type, allowing downsizing of the equipment and reduction of the number of parts
- Available in a type with radial taping

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter		Symbol	Rating	Unit
Collector-base voltage	UNR8231	V _{CBO}	20	V
(Emitter open)	UNR8231A		60	
Collector-emitter	UNR8231	V _{CEO}	20	V
voltage (Base open)	UNR8231A		50	
Collector current	1 _c	0.7	A	
Peak collector current	I _{CP}	1.5	А	
Total power dissipation *		P _T	1	W
Junction temperature	Tj	150	°C	
Storage temperature		T _{stg}	-55 to +150	°C



Internal Connection

$R_{1}(1,k\Omega) = C$

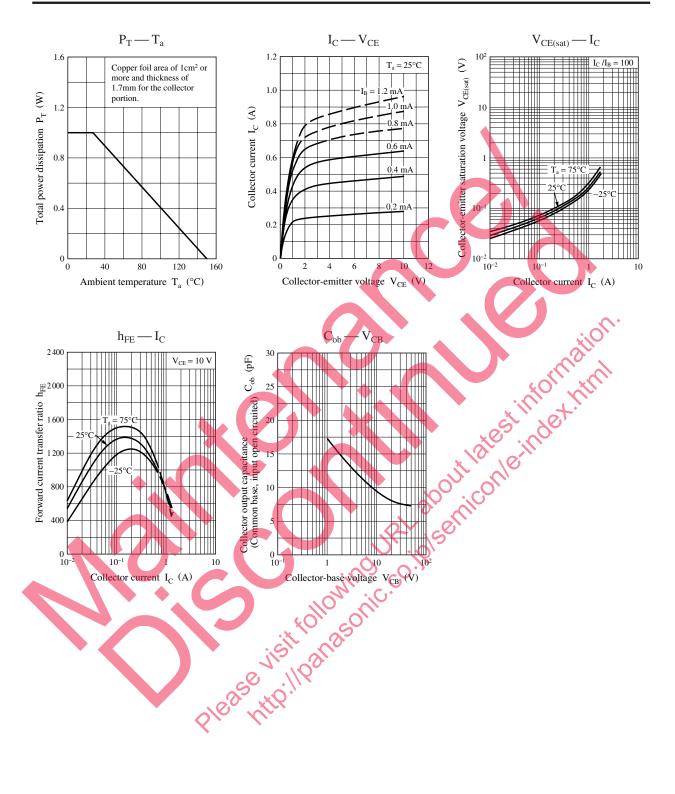
Note) *: Printed circuit board: Copper foil area of 1 cm² or more, and the board thickness of 1.7 mm for the collector portion

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage UNR8231	V _{CBO}	$I_{\rm C} = 10 \mu {\rm A}, I_{\rm E} = 0$	20			V
(Emitter open) UNR8231A			60			
Collector-emitter UNR8231	V _{CEO}	$I_{\rm C} = 1$ mA, $I_{\rm B} = 0$	20			V
voltage (Base open) UNR8231A		1100	50			
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{\rm CB} = 15 \text{ V}, I_{\rm E} = 0$			1	μΑ
Collector-emitter cutoff current (Base open)	I _{CEO}	$V_{CE} = 15 \text{ V}, I_B = 0$			10	μΑ
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = 14 \text{ V}, I_C = 0$			0.5	mA
Forward current transfer ratio *	h _{FE}	$V_{CE} = 10 \text{ V}, I_C = 150 \text{ mA}$	800		2 100	
Collector-emitter saturation voltage *	V _{CE(sat)}	$I_{C} = 500 \text{ mA}, I_{B} = 5 \text{ mA}$			0.4	V
Input resistance	R ₁		0.7	1.0	1.3	kΩ
Resistance ratio	R ₁ /R ₂		0.016	0.021	0.025	—
Transition frequency	f _T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. *: Pulse measurement

Note) The part numbers in the parenthesis show conventional part number.



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